

## Product Change Notification - KSRA-25CZMD564

(Printer Friendly)

**Date:**

27 Oct 2017

**Product Category:****Notification subject:**

CCB 3135 Initial Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products for 250K wafer technology available in 40L UQFN package at NSEB assembly site

**Notification text:****PCN Status:**

Initial notification

**Microchip Parts Affected:**

Please open the attachments found in the attachments field below labeled as PCN\_#\_Affected\_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**

Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products for 250K wafer technology available in 40L UQFN package at NSEB assembly site

**Pre Change:**

Using gold (Au) bond wire material.

**Post Change:**

Using palladium coated copper with gold flash (CuPdAu) bond wire material.

**Pre and Post Change Summary:**

|               | Pre Change                                 | Post Change                                |
|---------------|--|--|
| Assembly Site | UTAC Thai Limited LTD (NSEB) Assembly Site | UTAC Thai Limited LTD (NSEB) Assembly Site |



**Method to Identify Change:**

Traceability code

**Qualification Plan:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual Plan

**Revision History:**

**October 27, 2017:** Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):**

[PCN\\_KSRA-25CZMD564\\_Affected CPN.pdf](#)

[PCN\\_KSRA-25CZMD564\\_Qual Plan.pdf](#)

[PCN\\_KSRA-25CZMD564\\_Affected CPN.xlsx](#)

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